



IS410

IS410 is a high-performance FR-4 epoxy laminate and prepreg system designed to support the printed circuit board industry's requirements for higher levels of reliability and the trend to use lead-free solder.

Isola's IS410 has a glass transition temperature (Tg) of 180°C and is specially formulated for superior performance through multiple thermal excursions, passing 6X solder tests at 288°C. IS410 is optimized for enhanced drilling performance allowing high aspect ratio holes of $\varnothing$ 10 mils. Its unique resin chemistry provides CAF resistance with the benefit of long-term reliability of boards built with small feature designs.

ORDERING INFORMATION:

Contact your local sales representative or visit www.isola-group.com for further information.

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Performance

Tg 180°C

Td 350°C

Dk 3.97

Df 0.02

zIPC- 4101C /21 /24 /26 /98 /101 /126

UL - File Number E41625

Qualified to UL's MCIL Program

Product Features

- Industry Recognition
 - UL File Number: E41625
 - RoHS Compliant
- Performance Attributes
 - Lead-free assembly compatible
 - 6x 288°C solder float capable
- Processing Advantages

Product Availability

- Standard Material Offering: Laminate
 - 2 to 125 mil (0.05 to 3.2 mm)
 - Available in full size sheet or panel form
- Copper Foil Type
 - HTE Grade 3
 - RTF (Reverse Treat Foil)
- Copper Weight
 - ½ to 2 oz (18 to 70 μ m) available
 - Heavier copper available
 - Thinner copper foil available
- Standard Material Offering: Prepreg
 - Roll or panel form
 - Tooling of prepreg panels
- Glass Fabric Availability
 - E-glass
 - Square weave glass

IS410 Specifications

Property		Typical Value	Units	Test Method
			Metric (English)	IPC-TM-650 (or as noted)
Glass Transition Temperature (Tg) by DSC		180	°C	2.4.25
Decomposition Temperature (Td) by TGA @ 5% weight loss		350	°C	2.4.24.2
Time to Delaminate by TMA (Copper removed)	A. T260 B. T288	50 10	Minutes	2.4.24.1
Z-Axis CTE	A. Pre-Tg B. Post-Tg C. 50 to 260°C, (Total Expansion)	55 250 3.5	ppm/°C ppm/°C %	2.4.24
X/Y-Axis CTE	Pre-Tg	11	ppm/°C	2.4.24.1
Thermal Conductivity		0.5	W/mK	ASTM E1952
Thermal Stress 10 sec @ 288°C (550.4°F)	A. Unetched B. Etched	Pass	Pass Visual	2.4.13.1
Dk, Permittivity	A. @ 100 MHz B. @ 1 GHz C. @ 2 GHz D. @ 5 GHz E. @ 10 GHz	3.96 3.90 3.97 3.87 3.87	—	2.5.5.3 2.5.5.9 Bereskin Stripline Bereskin Stripline Bereskin Stripline
Df, Loss Tangent	A. @ 100 MHz B. @ 1 GHz C. @ 2 GHz D. @ 5 GHz E. @ 10 GHz	0.0149 0.0189 0.0200 0.0230 0.0230	—	2.5.5.3 2.5.5.9 Bereskin Stripline Bereskin Stripline Bereskin Stripline
Volume Resistivity	A. After moisture resistance B. At elevated temperature	8.0×10^8 3.6×10^8	MΩ-cm	2.5.17.1
Surface Resistivity	A. After moisture resistance B. At elevated temperature	8.0×10^6 $4.5 \times 10(8)$	MΩ	2.5.17.1
Dielectric Breakdown		>50	kV	2.5.6
Arc Resistance		129	Seconds	2.5.1
Electric Strength (Laminate & laminated prepreg)		44 (1100)	kV/mm (V/mil)	2.5.6.2
Comparative Tracking Index (CTI)		3 (175-249)	Class (Volts)	UL 746A ASTM D3638
Peel Strength	A. Low profile copper foil and very low profile copper foil all copper foil >17 μm [0.669 mil] B. Standard profile copper 1. After thermal stress 2. At 125°C (257°F) 3. After process solutions	1.14 (6.5) 1.225 (7.0) 1.14 (6.5) 0.90 (5.1)	N/mm (lb/inch)	2.4.8 2.4.8.2 2.4.8.3 2.4.8.3
Flexural Strength	A. Length direction B. Cross direction	82,600 66,400	lb/inch ²	2.4.4
Tensile Strength	A. Length direction B. Cross direction	60,890 45,750	lb/inch ²	ASTM D3039
Poisson's Ratio	A. Length direction B. Cross direction	0.175 0.143	—	ASTM D3039
Moisture Absorption		0.20	%	2.6.2.1
Flammability (Laminate & laminated prepreg)		V-0	Rating	UL 94
Max Operating Temperature		130	°C	UL 796

The data, while believed to be accurate and based on analytical methods considered to be reliable, is for information purposes only. Any sales of these products will be governed by the terms and conditions of the agreement under which they are sold.

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